

Deal in the Used Equipment

We sell and provide comprehensive after-sales service for the equipments of the customers. We procure the used equipments made by Shinkawa Ltd., and be refurbished by engineer handled professional skills.
 We can modify the used equipments to the customer's specifications with refurbishment depend on your request.

Refurbishment Base



Please contact us if you wish to purchase or sell



Phone: +81-42-560-1285


Fax: +81-42-560-0844


Contact Us ▼


skwt-sal@ymrh.co.jp



INVENTORY INFORMATION


Wire Bonder Model UTC-3000 / WE (Stock Example)	Stock Quantity: 10	
	The Date of manufacture	Jul. 2008
	Storage Location	JAPAN
	Notice	Standard specification
	Bond Area	X=±28mm Y=±36mm
	AC Nonsticking Detection	3pF Type
		



Wire Bonder Model UTC-2000 Super (Stock Example)	Stock Quantity: 5	
	The Date of manufacture	Nov. 2007
	Storage Location	JAPAN
	Notice	Standard specification
	Bond Area	X=±28mm Y=±33mm
	AC Nonsticking Detection	3pF Type


Wire Bonder Model UTC-2000		Stock Quantity: 1	
(Stock Information)			
	The Date of manufacture	Jun. 2007	
	Storage Location	JAPAN	
	Notice	Standard specification	
	Bond Area	X=±28mm Y=±33mm	
	AC Nonsticking Detection	3pF Type	


Wire Bonder Model UTC-1000Super		Stock Quantity: 33	
(Stock Example)			
	The Date of manufacture	Mar. 2007	
	Storage Location	JAPAN	
	Notice	Standard specification	
	Bond Area	X=±28mm Y=±33mm	

Wire Bonder Model ACB-3000		Stock Quantity: 10	
(Stock Example)			
	The Date of manufacture	Sept. 2012	
	Storage Location	JAPAN	
	Notice	Standard specification	
			

Die Bonder Model STC-500		Stock Quantity: 1	
(Stock Information)			
	The Date of manufacture	May. 2007	
	Storage Location	JAPAN	
	Notice	Standard specification	

Die Bonder Model SPA-400		Stock Quantity: 4	
(Stock Information)			
	The Date of manufacture	Sept. 2007	
	Storage Location	JAPAN	
	Notice	Standard specification	
			

Bump Bonder Model: SBB-1410		Stock Quantity: 1	
(Stock Information)			
	The Date of manufacture	Jan. 2006	
	Storage Location	JAPAN	
	Notice	Standard specification	

Bump Bonder Model: SBB-1100S		Stock Quantity: 4	
(Stock Example)			
	The Date of manufacture	Sept. 2011	
	Storage Location	JAPAN	
	Notice	Standard specification	
	